

ACUROS® CQD® 640L GigE eSWIR Camera

ACUROS-0640-GigE-004

The ACUROS CQD L-Series SWIR cameras feature large sensor area, low angular dependence and a short working distance for highly divergent emitters. ACUROS cameras deliver high resolution, high dynamic range and very high detectivity imaging to 2000 nm.

The L-Series cameras are designed for use exclusively in laser beam diagnostics, laser beam imaging and laser alignment applications.



SPECIFICATIONS

Table 1. ELECTRO-OPTICAL SPECIFICATIONS

Parameter	Value/Description
Sensor	ACUROS CQD sensor
Temperature Stabilization	Single-stage thermo-electric cooler
Sensor Array Format	640 x 512
Resolution	0.33 MP (megapixel)
Spectral Band	350–2000 nm
Array Size	9.6 mm x 7.7 mm, 12.3 mm diagonal
Pixel Pitch	15 μm x 15 μm
Max Frame Rate at Full Resolution	270 fps (8 bit), 180 fps (10, 12, 14 bit)
Pixel Operability	99.9% typical, 99.75% min
Bit Depth	8, 10, 12, 14 bit selectable
Integration Type	Snapshot global shutter
Trigger	External TTL
Integration Time	100 μs to 4 s
Dynamic Range	65 dB typical
Windowing & Windowing Frame Rate	Array centered. Scales inversely to window size
Laser Beam Fringeless Operation	Yes
Binning Arrays	2 x 2, 4 x 4
Non-uniformity Correction	2-point non-uniformity correction
Temporal Dark Noise	80/70/65 e ⁻ typical
Quantum Efficiency	See typical QE curve (Figure 4)

ORDERING INFORMATION

Part Number
ACUROS-0640-GigE-004

Features

- Large Sensor Size
- Short Working Distance for Highly Divergent Beams
- Low Angular Dependence
- Dynamic Range up to 70 dB
- Linear Photoresponse
- VGA Resolution
- TEC Cooling
- Low Noise
- GigE Vision
- Visible-eSWIR

Applications

- Laser Beam Diagnostics
- Laser Beam Imaging
- Laser Alignment

ACUROS-0640-GigE-004

Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

Parameter	Value/Description
Operating Case Temperature	-20 °C to +55 °C
Power Consumption	6.5–12 W depending on TEC settings
Power Supply Voltage	6–16 V dc. POE not supported
Regulatory Compliance	CE mark

Table 3. MECHANICAL SPECIFICATIONS

Parameter	Value/Description
Dimensions Excluding Lens	6.1 x 6.1 x 9.8 cm
Weight Excluding Lens	505 grams
Lens Mounts	Standard mount. Inquire for other options.
Power Connector	Hirose 12-pin, HR10A-10R-12PB (71)
Trigger Connector	BNC

Table 4. SOFTWARE AND USER INTERFACE

Parameter	Value/Description
Software Development Kit	Windows GUI & Pleora eBUS SDK (Linux, Windows, macOS)
GenICam Compliance	Yes
Interface	GigE Vision

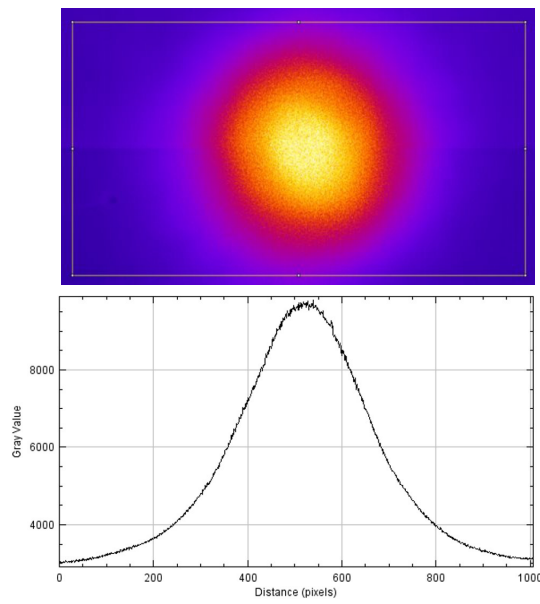


Figure 1.



Figure 2. GigE Vision Interface

ACUROS-0640-GigE-004



1550 nm Laser image and corresponding line file
(false color added post image)

Figure 3. ACUROS CQD SWIR Camera Image of Laser

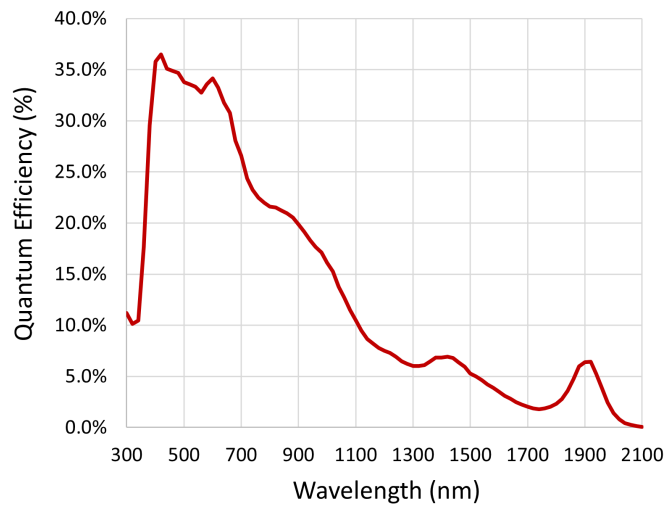
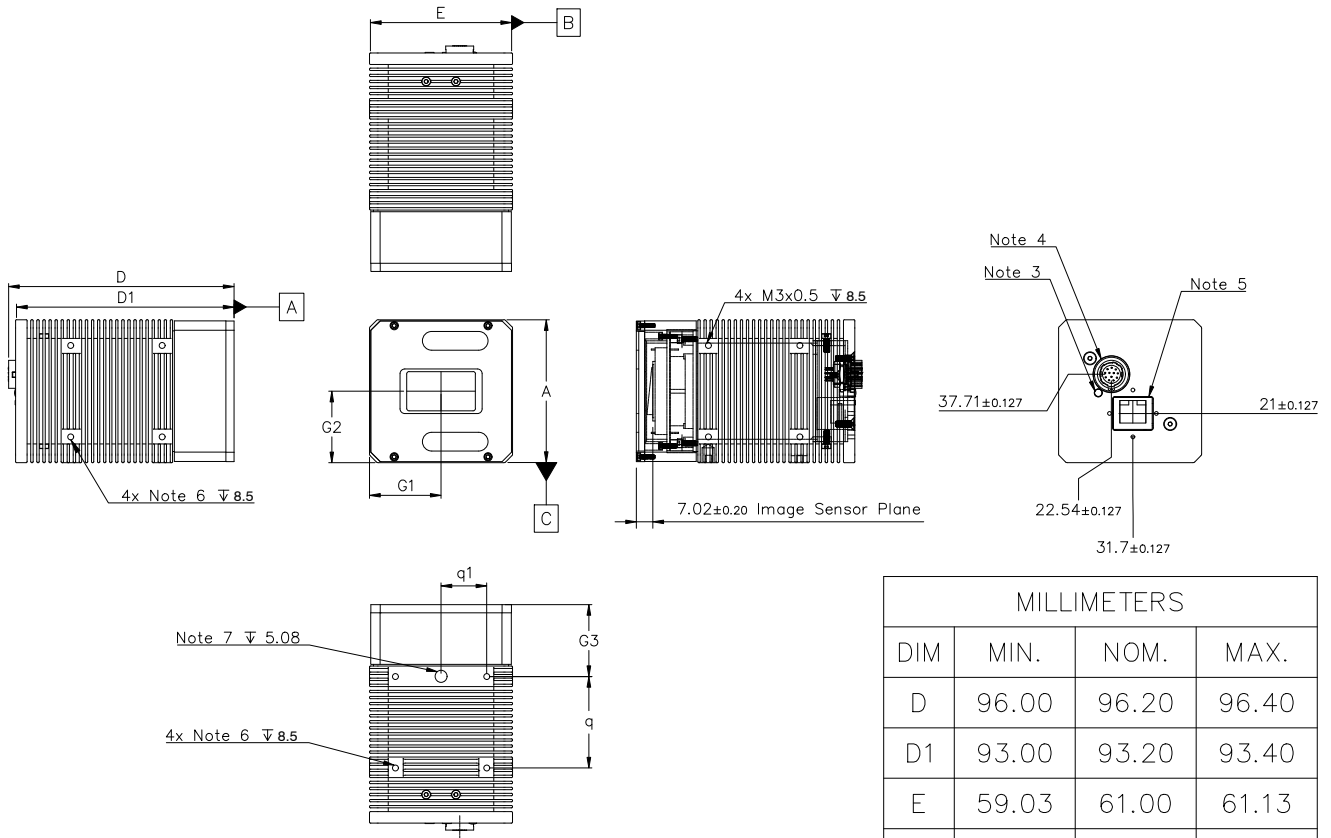


Figure 4. Typical QE Performance

ACUROS, CQD and SWIR VISION SYSTEMS are registered trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. All other brand names and product names appearing in this document are registered trademarks or trademarks of their respective holders.

CMOD 96.20x61.00x61.00
CASE 810AD
ISSUE A

DATE 18 NOV 2024



MILLIMETERS			
DIM	MIN.	NOM.	MAX.
D	96.00	96.20	96.40
D1	93.00	93.20	93.40
E	59.03	61.00	61.13
A	59.03	61.00	61.13
G1	30.35	30.48	30.61
G2	30.35	30.48	30.61
G3	30.47	30.60	30.73
q	38.98	39.11	39.24
q1	19.37	19.50	19.63

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 2018.
2. CONTROLLING DIMENSION: MILLIMETER
3. POWER INIDCATOR
4. HIROSE 12 PIN CONNECTOR
5. GigE CONNECTOR
6. M3X0.5 DEPTH ∇ 8.5.
7. 1/4–20 UNC DEPTH ∇ 5.08

DOCUMENT NUMBER:	98AON65071H	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	CMOD 96.20x61.00x61.00	PAGE 1 OF 1

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales